### 504098238 11/16/2016

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4144907

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
RICHARD STIRLING-GALLACHER	11/10/2016
BIN LIU	11/10/2016
MAJID GHANBARINEJAD	11/10/2016
QIAN CHENG	11/10/2016

#### **RECEIVING PARTY DATA**

Name:	FutureWei Technologies, Inc.
Street Address:	5340 Legacy Drive
Internal Address:	Suite 175
City:	Plano
State/Country:	TEXAS
Postal Code:	75024

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15352802

#### **CORRESPONDENCE DATA**

**Fax Number:** (972)732-9218

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** (972)732-1001

**Email:** docketing@slatermatsil.com

Correspondent Name: SLATER MATSIL, LLP
Address Line 1: 17950 PRESTON ROAD

Address Line 2: SUITE 1000

Address Line 4: DALLAS, TEXAS 75252

ATTORNEY DOCKET NUMBER:	HW 85059477US02	
NAME OF SUBMITTER:	MARANDA BREWSTER	
SIGNATURE:	/Maranda Brewster/	
<b>DATE SIGNED:</b> 11/16/2016		
	This document serves as an Oath/Declaration (37 CFR 1.63).	

PATENT 504098238 REEL: 040342 FRAME: 0615

# **Total Attachments: 3**

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PATENT REEL: 040342 FRAME: 0616

#### ASSIGNMENT

WHEREAS, I/We, the undersigned inventor(s) (or one of the undersigned joint inventors), of residence as listed below, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, Futurewei Technologies, Inc. ("Assignee"), a corporation organized and existing under the laws of Texas, with its principal office at 5340 Legacy Drive, Suite 175, Plano, TX 75024 is desirous of acquiring my/our entire right, title and interest in the said invention, and to the said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I/we will assign, and hereby assign and transfer to the Assignee and the Assignee's legal representatives, successors and assigns the full and exclusive right, title and interest in and to the invention in the United States and every foreign country and the entire right, title, and interest in and to the patent application and other such applications (e.g., provisional applications, non-provisional applications, continuations, continuations-in-part, divisional, reissues, reexaminations, National Phase applications, including petty patent applications, and utility model applications) that may be filed in the United States and every foreign country on the invention, and the patents, extensions, or derivations thereof, both foreign and domestic, that may issue thereon, and I/we do hereby authorize and request the Commissioner for Patents to issue U.S. patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the Assignee agreeably with the terms of this assignment document.

I also hereby agree to sell and to assign, and sell and assign to Assignee, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to Assignee, or its successors, assigns, and legal representative, any facts know to me respecting said invention or the file history thereof, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid such Futurewei, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

Futurewei Technologies, Inc. Patent Reference No. 85059477US02 Page 1 of 2

## ASSIGNMENT

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

Title of Invention	System and Method for Beamformed Broadcast and		
	Synchronization Signals in Massive Multiple Input Multiple		
	Output Communications Systems		
	Appl. No.	Filing Date:	
	2° 29 65 5		
Signature of	E. D. Shirting - Callado		
Inventor			
Inventor Name	Richard Stirling-Gallacher		
Date	11/10/2016		
Residence	San Diego, CA		
(City/State)			
Signature of	7		
Inventor	1		
Inventor Name	Bin Liu		
Date	11/10/2016		
Residence	San Diego, CA		
(City/State)			
Signature of			
Inventor			
Inventor Name	Majid Ghanbarinejad		
Date			
Residence	Rolling Meadows, IL		
(City/State)			
Signature of			
Inventor			
Inventor Name	Qian Cheng		
Date			
Residence	Aurora, II.		
(City/State)			
Signature of			
Inventor			

Futurewei Technologies, Inc. Patent Reference No. 85059477US02

Page 2 of 2

### ASSIGNMENT

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

Title of Invention	System and Method for Beamformed Broadcast and Synchronization Signals in Massive Multiple Input Multiple Output Communications Systems	
	Appl. No.	Filing Date:
Signature of Inventor	^	
Inventor Name	Richard Stirling-Gallacher	
Date		
Residence (City/State)	San Diego, CA	
Signature of Inventor		
Inventor Name	Bin Liu	
Date		
Residence (City/State)	San Diego, CA	
Signature of Inventor	4. Chabair	
Inventor Name	Majid Ghanbarinejad	
Date	11/10/2016	
Residence	Rolling Meadows, II.	
(City/State)	winds.	
Signature of Inventor	any	
Inventor Name	Qian Chéng	
Date	11/1n/2016	
Residence	Aurora, II.	
(City/State)		
Signature of		
Inventor		

Futurewei Technologies, Inc. Patent Reference No. 85059477US02

**RECORDED: 11/16/2016** 

**PATENT** REEL: 040342 FRAME: 0619